

## STF43N60DM2

# N-channel 600 V, 0.085 Ω typ., 34 A MDmesh™ DM2 Power MOSFET in a TO-220FP package

Datasheet - production data

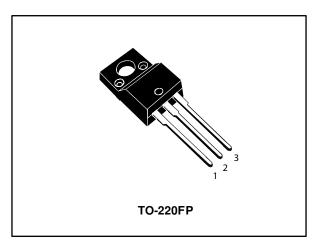
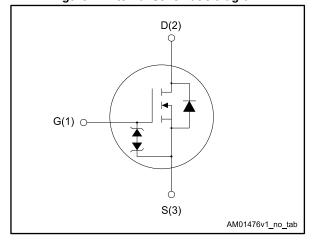


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub> @ T <sub>jmax.</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>	P <sub>TOT</sub>
STF43N60DM2	650 V	0.093 Ω	34 A	40 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

### **Applications**

• Switching applications

### Description

This high voltage N-channel Power MOSFET is part of the MDmesh<sup>TM</sup> DM2 fast recovery diode series. It offers very low recovery charge ( $Q_{rr}$ ) and time ( $t_{rr}$ ) combined with low  $R_{DS(on)}$ , rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STF43N60DM2	43N60DM2	TO-220FP	Tube

Contents STF43N60DM2

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STF43N60DM2 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
$V_{GS}$	Gate-source voltage	±25	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>case</sub> = 25 °C	34	Α
ID	Drain current (continuous) at T <sub>case</sub> = 100 °C	21	А
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	136	Α
P <sub>TOT</sub>	Total dissipation at T <sub>case</sub> = 25 °C	40	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	50	V/ns
dv/dt <sup>(4)</sup>	MOSFET dv/dt ruggedness	50	V/IIS
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_C = 25$ °C)	2500	V
T <sub>stg</sub>	Storage temperature	EE to 1E0	°C
T <sub>j</sub>	Operating junction temperature	-55 to 150	10

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	0.32	0 <b>0 AM</b>
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive	6	Α
E <sub>AS</sub> <sup>(1)</sup>	Single pulse avalanche energy	800	mJ

### Notes:

 $<sup>^{\</sup>left( 1\right) }$  limited by maximum junction temperature.

 $<sup>\,^{(2)}</sup>$  Pulse width is limited by safe operating area.

 $<sup>^{(3)}</sup>$   $I_{SD} \leq 34$  A, di/dt=900 A/µs;  $V_{DS}$  peak <  $V_{(BR)DSS},$   $V_{DD}$  = 400 V.

 $<sup>^{(4)}</sup> V_{DS} \le 480 V.$ 

 $<sup>^{(1)}</sup>$  starting  $T_j = 25~^{\circ}\text{C},~I_D = I_{AR},~V_{DD} = 50~\text{V}.$ 

Electrical characteristics STF43N60DM2

## 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Table 5: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	600			V
	Zoro goto voltago droin	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V}$			1	
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 600 \text{ V},$ $T_{case} = 125 \text{ °C}$			100	μΑ
I <sub>GSS</sub>	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±5	μΑ
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 17 A		0.085	0.093	Ω

Table 6: Dynamic

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		ı	2500	ı	
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	1	120	1	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0 V$	-	3	-	ρ.
Coss eq. (1)	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	200	-	рF
$R_{G}$	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4	-	Ω
$Q_g$	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 34 \text{ A},$	1	56	1	
$Q_{gs}$	Gate-source charge	V <sub>GS</sub> = 10 V (see <i>Figure 15:</i>		13	-	nC
$Q_{gd}$	Gate-drain charge	"Gate charge test circuit")	•	30	-	

#### Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 25 \text{ A}$	ı	29	1	
t <sub>r</sub>	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 14: "Switching	-	27	-	
t <sub>d(off)</sub>	Turn-off delay time	times test circuit for	ı	85	1	ns
t <sub>f</sub>	Fall time	resistive load" and Figure 19: "Switching time waveform")	ı	6	1	

 $<sup>^{(1)}</sup>$   $C_{oss\ eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> <sup>(1)</sup>	Source-drain current		1		34	Α
I <sub>SDM</sub> <sup>(2)</sup>	Source-drain current (pulsed)		ı		136	Α
V <sub>SD</sub> <sup>(3)</sup>	Forward on voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 34 \text{ A}$	1		1.6	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 34 A$	1	120		ns
$Q_{rr}$	Reverse recovery charge	di/dt = 100 A/ $\mu$ s, V <sub>DD</sub> = 60 V (see <i>Figure 16</i> :	-	0.6		μC
I <sub>RRM</sub>	Reverse recovery current	"Test circuit for inductive load switching and diode recovery times")	-	10.4		А
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 34 A,	-	240		ns
Q <sub>rr</sub>	Reverse recovery charge	di/dt = 100 A/μs, V <sub>DD</sub> = 60 V, T <sub>i</sub> = 150 °C	-	2.4		μC
	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	20.5		А

### Notes:

 $<sup>^{\</sup>left( 1\right) }$  Limited by maximum junction temperature.

 $<sup>\,^{(2)}</sup>$  Pulse width is limited by safe operating area.

 $<sup>^{(3)}</sup>$  Pulse test: pulse duration = 300  $\mu s,$  duty cycle 1.5%.

# 2.1 Electrical characteristics (curves)

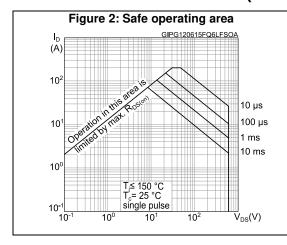
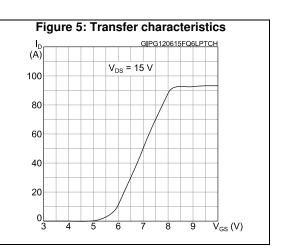
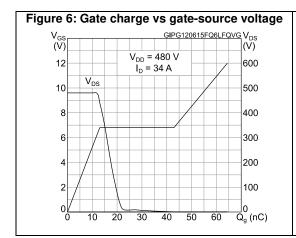
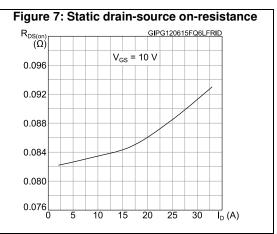


Figure 3: Thermal impedance K  $\delta = 0.5$   $\delta = 0.2$   $\delta = 0.1$   $\delta = 0.02$   $\delta = 0.01$   $\delta = 0.05$   $\delta = 0.05$ 







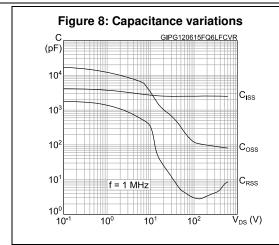


Figure 10: Normalized on-resistance vs temperature

R<sub>DS(on)</sub> GIPG120615FQ6LPRON
(norm.)

2.2

V<sub>GS</sub> = 10 V

1.8

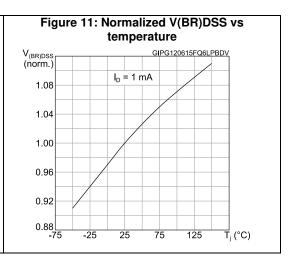
1.4

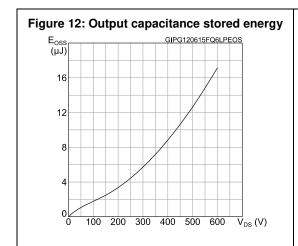
1.0

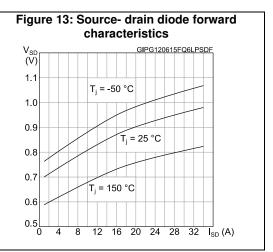
0.6

0.2

-75
-25
25
75
125
T<sub>j</sub> (°C)

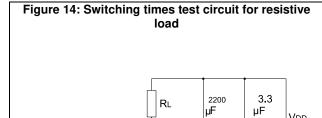






**Test circuits** STF43N60DM2

#### 3 **Test circuits**





Vdd

Figure 15: Gate charge test circuit I<sub>G</sub> = CONST 2.7 kΩ 2200 µF AM01469v1

Figure 16: Test circuit for inductive load switching and diode recovery times

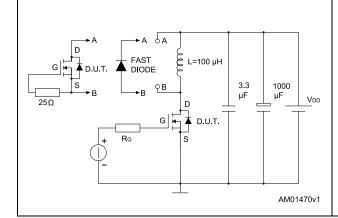
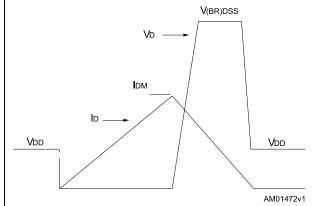
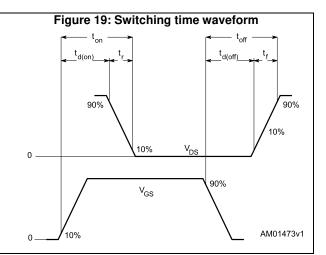


Figure 17: Unclamped inductive load test circuit 2200 VDD AM01471v1

Figure 18: Unclamped inductive waveform





# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



# 4.1 TO-220FP package information

Figure 20: TO-220FP package outline

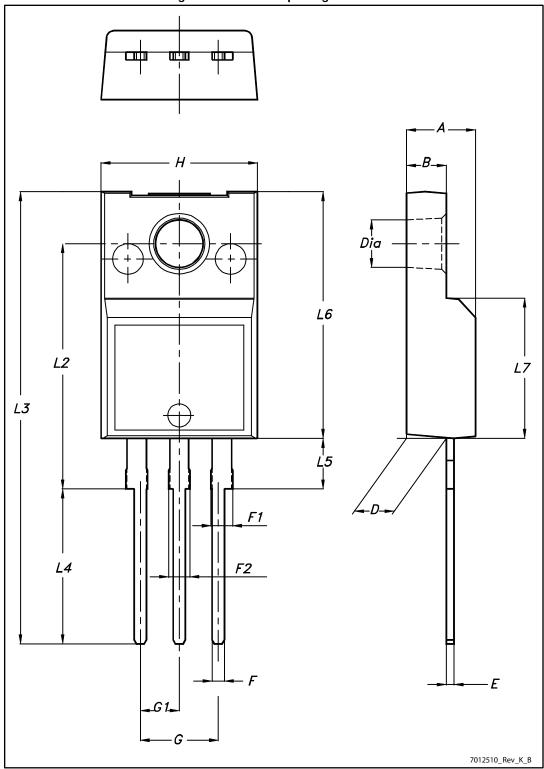


Table 9: TO-220FP package mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Revision history STF43N60DM2

# 5 Revision history

Table 10: Document revision history

Date	Revision	Changes
06-Aug-2014	1	First release.
01-Jul-2015	2	Text and formatting changes throughout document Datasheet promoted from preliminary data to production data On cover page: - updated title description - updated features table In Section Electrical ratings: - updated Table Absolute maximum ratings - updated Table Thermal data - updated Table Avalanche characteristics In Section Electrical characteristics: - updated and renamed Table Static (was On/off states) - updated Table Dynamic - updated Table Switching times - updated Table Source-drain diode Added Section 2.1 Electrical characteristics (curves)

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